Ferrites and accessories

P 26 × 16
Core and accessories

Series/Type: **B65671, B65672, B65675, B65679**

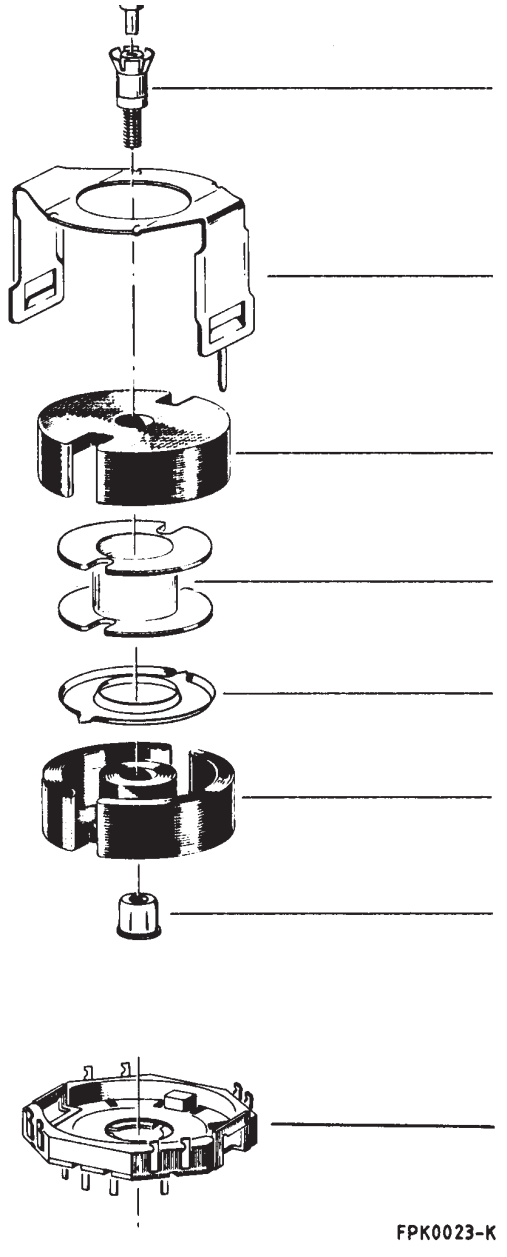
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P 26 × 16

Core and accessories



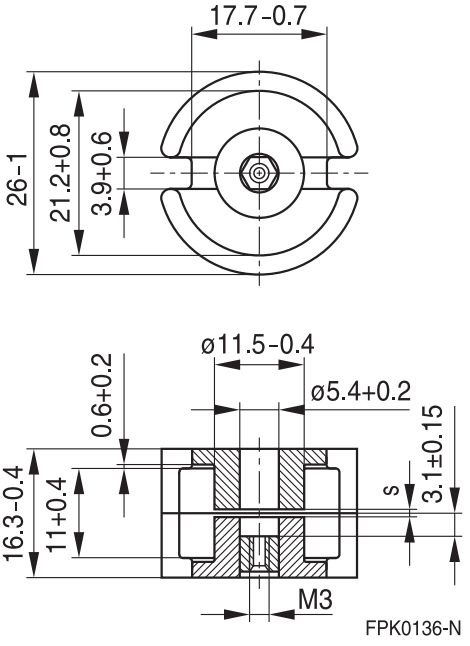
Individual parts	Part no.	Page
Adjusting screw	B65679	7
Yoke	B65675	6
Core	B65671	3
Coil former	B65672	5
Insulating washer		
Core	B65671	3
Threaded sleeve (glued-in)		
Terminal carrier	B65675	6

Example of an assembly set
for printed circuit boards

P 26 × 16

Core B65671

- To IEC 62317-2
- Delivery mode: sets



Magnetic characteristics (per set)

	with center hole	without center hole	
$\Sigma l/A$	0.4	0.37	mm^{-1}
l_e	37.2	40	mm
A_e	93	108	mm^2
A_{min}	76.5	87	mm^2
V_e	3460	4320	mm^3

Approx. weight (per set)

m	21	23	g

Gapped (A_L values/air gaps examples)

Material	A_L value nH	s approx. mm	μ_e	Ordering code [1)] -D with center hole -T with threaded sleeve
K1	100 ±3%	0.90	32	B65671+0100A001
M33	100 ±3%	1.52	32	B65671+0100A033
	160 ±3%	0.78	51	B65671+0160A033
N48	160 ±3%	0.80	51	B65671+0160A048
	250 ±3%	0.40	80	B65671+0250A048
	315 ±3%	0.34	100	B65671+0315A048
	400 ±3%	0.24	127	B65671+0400A048
	630 ±3%	0.15	201	B65671+0630A048
	800 ±3%	0.11	255	B65671+0800A048
	1000 ±5%	0.10	318	B65671D1000J048

1) Replace the + by the code letter ”D“ or ”T“ for the required version.

P 26 × 16

Core B65671

Ungapped

Material	A_L value nH	μ_e	P_V W/set	Ordering code -D with center hole -W without center hole
K1	270 +30/–20%	90		B65671D0000R001
M33	2000 +30/–20%	640		B65671D0000R033
N48	4900 +30/–20%	1560		B65671D0000R048
N30	9700 +30/–20%	2860		B65671W0000R030
T38	22000 +40/–30%	6480		B65671W0000Y038
N87	5500 +30/–20%	1620	< 1.9 (200 mT, 100 kHz, 100 °C)	B65671W0000R087

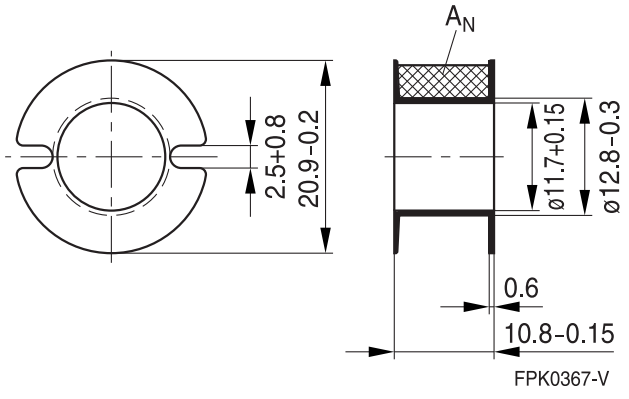
Other A_L values/air gaps and materials available on request – see Processing remarks on page 8.

Coil former

Standard: to IEC 62317-2
Material: GFR polyterephthalate (UL 94 V-0, insulation class to IEC 60085:
F ≙ max. operating temperature 155 °C), color code black
Valox 420-SE0 [E207780 (M)] SABIC JAPAN L L C
Winding: see Processing notes, 2.1

Coil former				Ordering code
Sections	A_N mm²	l_N mm	A_R value μΩ	
1	32.0	52	55	B65672B0000T001

Coil former



Mounting assembly for printed circuit boards

- The set comprises a terminal carrier and a yoke
- For snap-in connection

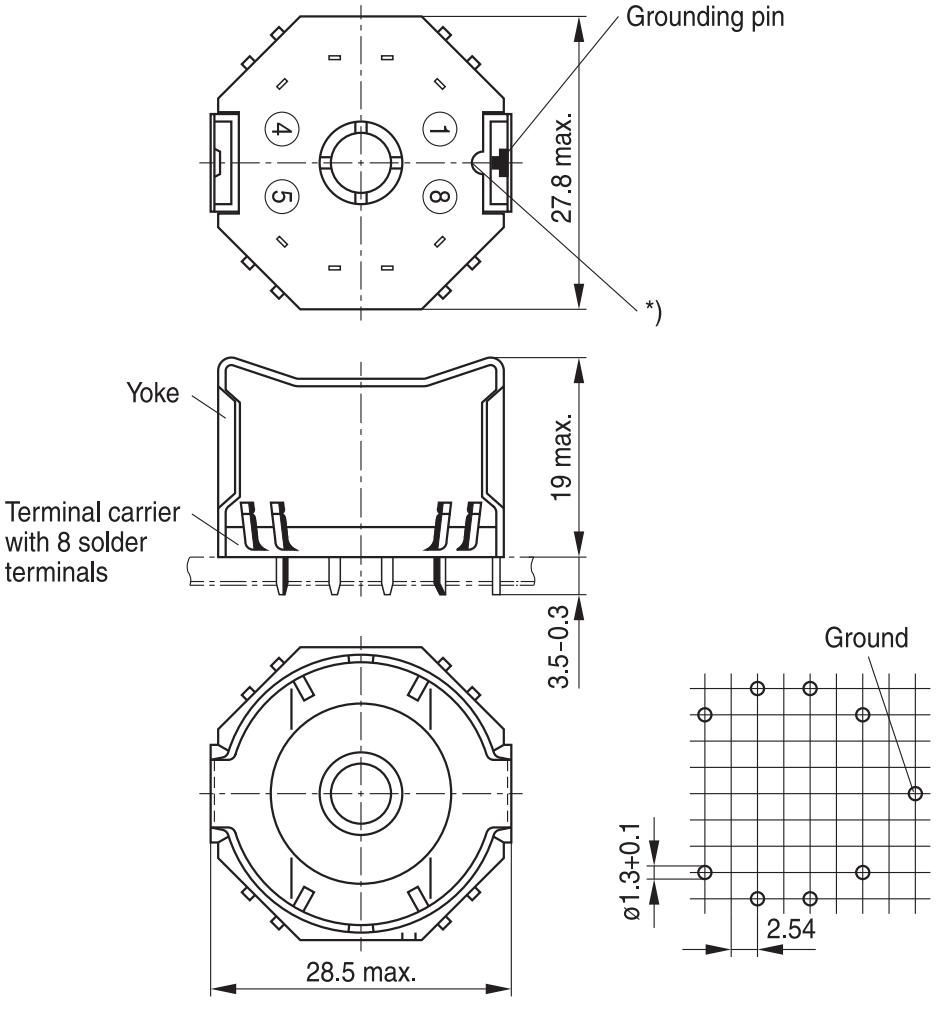
Terminal carrier

Material: GFR polyterephthalate (UL 94 V-0, insulation class to IEC 60085:
F ≙ max. operating temperature 155 °C), color code gray
Pocan B4235® [E245249 (M)], LANXESS AG
Solderability: to IEC 60068-2-20, test Ta, method 1 (aging 3): 235 °C, 2 s
Resistance to soldering heat: to IEC 60068-2-20, test Tb, method 1B: 350 °C, 3.5 s

Yoke

Spring yoke, made of tinned nickel silver (0.4 mm), with ground terminal

Complete mounting assembly (8 solder terminals)
Ordering code: B65675B0005X000



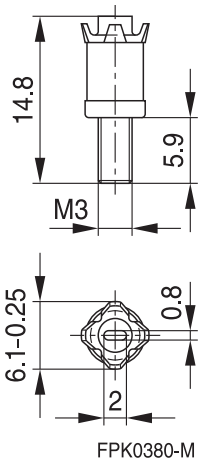
*) This recess must be on the side of the grounding pin to ensure that the yoke locks into position.

FPK0379-J-E

Adjusting screw

- Tube core with thread and core brake made of GFR polyterephthalate Pocan B3235® [E245249 (M)], LANXESS AG

Tube core ∅ × length (mm)	Material	Color code	Ordering code
4.55 × 6.3	N22	red	B65679E0003X022
4.98 × 6.3	N22	black	B65679E0002X022



Note:

Due to the limited distance between adjusting screw and internal borehole, the entire assembly must be accurately centered.

Mechanical stress and mounting

Ferrite cores have to meet mechanical requirements during assembling and for a growing number of applications. Since ferrites are ceramic materials one has to be aware of the special behavior under mechanical load.

As valid for any ceramic material, ferrite cores are brittle and sensitive to any shock, fast temperature changing or tensile load. Especially high cooling rates under ultrasonic cleaning and high static or cyclic loads can cause cracks or failure of the ferrite cores.

For detailed information see data book, chapter *"General - Definitions, 8.1"*.

Effects of core combination on A_L value

Stresses in the core affect not only the mechanical but also the magnetic properties. It is apparent that the initial permeability is dependent on the stress state of the core. The higher the stresses are in the core, the lower is the value for the initial permeability. Thus the embedding medium should have the greatest possible elasticity.

For detailed information see data book, chapter *"General - Definitions, 8.1"*.

Heating up

Ferrites can run hot during operation at higher flux densities and higher frequencies.

NiZn-materials

The magnetic properties of NiZn-materials can change irreversible in high magnetic fields.

Ferrite Accessories

EPCOS ferrite accessories have been designed and evaluated only in combination with EPCOS ferrite cores. EPCOS explicitly points out that EPCOS ferrite accessories or EPCOS ferrite cores may not be compatible with those of other manufacturers. Any such combination requires prior testing by the customer and will be at the customer‘s own risk.

EPCOS assumes no warranty or reliability for the combination of EPCOS ferrite accessories with cores and other accessories from any other manufacturer.

Processing remarks

The start of the winding process should be soft. Else the flanges may be destroyed.

- Too strong winding forces may blast the flanges or squeeze the tube that the cores can not be mounted any more.
- Too long soldering time at high temperature (>300 °C) may effect coplanarity or pin arrangement.
- Not following the processing notes for soldering of the J-leg terminals may cause solderability problems at the transformer because of pollution with Sn oxyde of the tin bath or burned insulation of the wire. For detailed information see chapter *"Processing notes"*, section 2.2.
- The dimensions of the hole arrangement have fixed values and should be understood as a recommendation for drilling the printed circuit board. For dimensioning the pins, the group of holes can only be seen under certain conditions, as they fit into the given hole arrangement. To avoid problems when mounting the transformer, the manufacturing tolerances for positioning the customers' drilling process must be considered by increasing the hole diameter.

Display of ordering codes for EPCOS products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of EPCOS, or in order-related documents such as shipping notes, order confirmations and product labels. **The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products**. Detailed information can be found on the Internet under www.epcos.com/orderingcodes.

Symbols and terms

Symbol	Meaning	Unit
A	Cross section of coil	mm^2
A_e	Effective magnetic cross section	mm^2
A_L	Inductance factor; $A_L = L/N^2$	nH
A_{L1}	Minimum inductance at defined high saturation ($\triangleq \mu_a$)	nH
A_{min}	Minimum core cross section	mm^2
A_N	Winding cross section	mm^2
A_R	Resistance factor; $A_R = R_{Cu}/N^2$	$\mu\Omega = 10^{-6}\ \Omega$
B	RMS value of magnetic flux density	Vs/m^2, mT
ΔB	Flux density deviation	Vs/m^2, mT
$\hat{B}$	Peak value of magnetic flux density	Vs/m^2, mT
$\Delta\hat{B}$	Peak value of flux density deviation	Vs/m^2, mT
B_{DC}	DC magnetic flux density	Vs/m^2, mT
B_R	Remanent flux density	Vs/m^2, mT
B_S	Saturation magnetization	Vs/m^2, mT
C_0	Winding capacitance	F = As/V
CDF	Core distortion factor	$mm^{-4.5}$
DF	Relative disaccommodation coefficient $DF = d/\mu_i$	
d	Disaccommodation coefficient	
E_a	Activation energy	J
f	Frequency	s^{-1}, Hz
f_{cutoff}	Cut-off frequency	s^{-1}, Hz
f_{max}	Upper frequency limit	s^{-1}, Hz
f_{min}	Lower frequency limit	s^{-1}, Hz
f_r	Resonance frequency	s^{-1}, Hz
f_{Cu}	Copper filling factor	
g	Air gap	mm
H	RMS value of magnetic field strength	A/m
$\hat{H}$	Peak value of magnetic field strength	A/m
H_{DC}	DC field strength	A/m
H_c	Coercive field strength	A/m
h	Hysteresis coefficient of material	10^{-6} cm/A
$h/\mu_i{}^2$	Relative hysteresis coefficient	10^{-6} cm/A
I	RMS value of current	A
I_{DC}	Direct current	A
$\hat{I}$	Peak value of current	A
J	Polarization	Vs/m^2
k	Boltzmann constant	J/K
k_3	Third harmonic distortion	
k_{3c}	Circuit third harmonic distortion	
L	Inductance	H = Vs/A

Symbols and terms

Symbol	Meaning	Unit
$\Delta L/L$	Relative inductance change	H
L_0	Inductance of coil without core	H
L_H	Main inductance	H
L_p	Parallel inductance	H
L_{rev}	Reversible inductance	H
L_s	Series inductance	H
l_e	Effective magnetic path length	mm
l_N	Average length of turn	mm
N	Number of turns	
P_{Cu}	Copper (winding) losses	W
P_{trans}	Transferrable power	W
P_V	Relative core losses	mW/g
PF	Performance factor	
Q	Quality factor ($Q = \omega L/R_s = 1/\tan \delta_L$)	
R	Resistance	Ω
R_{Cu}	Copper (winding) resistance (f = 0)	Ω
R_h	Hysteresis loss resistance of a core	Ω
ΔR_h	R_h change	Ω
R_i	Internal resistance	Ω
R_p	Parallel loss resistance of a core	Ω
R_s	Series loss resistance of a core	Ω
R_{th}	Thermal resistance	K/W
R_V	Effective loss resistance of a core	Ω
s	Total air gap	mm
T	Temperature	°C
ΔT	Temperature difference	K
T_C	Curie temperature	°C
t	Time	s
t_v	Pulse duty factor	
$\tan \delta$	Loss factor	
$\tan \delta_L$	Loss factor of coil	
$\tan \delta_r$	(Residual) loss factor at $H \rightarrow 0$	
$\tan \delta_e$	Relative loss factor	
$\tan \delta_h$	Hysteresis loss factor	
$\tan \delta/\mu_i$	Relative loss factor of material at $H \rightarrow 0$	
U	RMS value of voltage	V
$\hat{U}$	Peak value of voltage	V
V_e	Effective magnetic volume	mm^3
Z	Complex impedance	Ω
Z_n	Normalized impedance $\lvert Z\rvert_n = \lvert Z\rvert / N^2 \times \varepsilon\ (l_e/A_e)$	Ω/mm

Symbols and terms

Symbol	Meaning	Unit
α	Temperature coefficient (TK)	1/K
α_F	Relative temperature coefficient of material	1/K
α_e	Temperature coefficient of effective permeability	1/K
ε_r	Relative permittivity	
Φ	Magnetic flux	Vs
η	Efficiency of a transformer	
η_B	Hysteresis material constant	mT^{-1}
η_i	Hysteresis core constant	$A^{-1}H^{-1/2}$
λ_s	Magnetostriction at saturation magnetization	
μ	Relative complex permeability	
μ_0	Magnetic field constant	Vs/Am
μ_a	Relative amplitude permeability	
μ_{app}	Relative apparent permeability	
μ_e	Relative effective permeability	
μ_i	Relative initial permeability	
μ_p'	Relative real (inductive) component of $\overline{\mu}$ (for parallel components)	
μ_p''	Relative imaginary (loss) component of $\overline{\mu}$ (for parallel components)	
μ_r	Relative permeability	
μ_{rev}	Relative reversible permeability	
μ_s'	Relative real (inductive) component of $\overline{\mu}$ (for series components)	
μ_s''	Relative imaginary (loss) component of $\overline{\mu}$ (for series components)	
μ_{tot}	Relative total permeability derived from the static magnetization curve	
ρ	Resistivity	Ωm^{-1}
$\Sigma l/A$	Magnetic form factor	mm^{-1}
τ_{Cu}	DC time constant $\tau_{Cu} = L/R_{Cu} = A_L/A_R$	s
ω	Angular frequency; $\omega = 2\ \Pi f$	s^{-1}

All dimensions are given in mm.

SMD Surface-mount device

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